

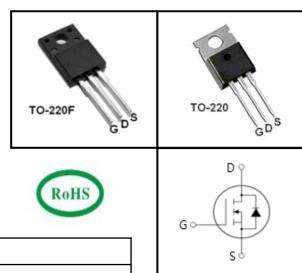
650V N-Channel MOSFET

FEATURES

- Fast switching
- 100% avalanche tested
- Improved dv/dt capability

APPLICATIONS

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply (UPS)
- Power Factor Correction (PFC)



Device Marking and Package Information			
Device	Package	Marking	
TMA12N65H	TO-220F	A12N65H	
TMP12N65H	TO-220	P12N65H	

Absolute Maximum Ratings $T_C = 25^{\circ}C$, unless otherwise noted					
Parameter	Symbol	Value		11!1	
Parameter		TO-220F	TO-220	Unit	
Drain-Source Voltage (V _{GS} = 0V)	V _{DSS}	650		V	
Continuous Drain Current	ntinuous Drain Current I _D		12		
Pulsed Drain Current (note1)	I _{DM}	48		А	
Gate-Source Voltage	V_{GSS}	±30		V	
Single Pulse Avalanche Energy (note2)	E _{AS} 810		10	mJ	
Avalanche Current (note1)	I _{AR}	9		А	
Repetitive Avalanche Energy (note1)	E _{AR}	54		mJ	
Power Dissipation (T _C = 25°C)	P _D	70	223	W	
Operating Junction and Storage Temperature Range	T _J , T _{stg}	-55~+150		°C	

Thermal Resistance					
Davamatas	Complete	Va	l lm!4		
Parameter	Symbol		TO-220	Unit	
Thermal Resistance, Junction-to-Case	R _{thJC}	1.78	0.56	•C/W	
Thermal Resistance, Junction-to-Ambient	R _{thJA}	62.5	60	30/00	

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			Value				
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	650			V	
Zero Gate Voltage Drain Current		$V_{DS} = 650V, V_{GS} = 0V, T_{J} = 25^{\circ}C$			1	μА	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 520V, V_{GS} = 0V, T_{J} = 125^{\circ}C$			50		
Gate-Source Leakage	$I_{\rm GSS}$	$V_{GS} = \pm 30V$			±100	nA	
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	3		4	V	
Drain-Source On-Resistance (Note3)	R _{DS(on)}	V _{GS} = 10V, I _D = 6A		0.55	0.65	Ω	
Dynamic							
Input Capacitance	C _{iss}	V - 0V		1540		pF	
Output Capacitance	C _{oss}	$V_{GS} = 0V,$ $V_{DS} = 25V,$		175			
Reverse Transfer Capacitance	C _{rss}	f = 1.0MHz		21			
Total Gate Charge	Q_g			44			
Gate-Source Charge	Q_{gs}	$V_{DD} = 520V, I_{D} = 12A,$ $V_{GS} = 10V$		8.6		nC	
Gate-Drain Charge	Q_{gd}			21			
Turn-on Delay Time	t _{d(on)}			30			
Turn-on Rise Time	t _r	$V_{DD} = 325V, I_{D} = 12A,$		12			
Turn-off Delay Time	t _{d(off)}	$R_G = 25\Omega$		95		ns	
Turn-off Fall Time	t _f			22			
Drain-Source Body Diode Characteris	stics	•					
Continuous Body Diode Current	Is	T 250C			12	Δ	
Pulsed Diode Forward Current	I _{SM}	$T_C = 25^{\circ}C$			48	Α	
Body Diode Voltage	V _{SD}	$T_J = 25^{\circ}C$, $I_{SD} = 12A$, $V_{GS} = 0V$			1.4	V	
Reverse Recovery Time	t _{rr}	$V_{GS} = 0V, I_F = 12A,$		380		ns	
Reverse Recovery Charge	Q _{rr}	di _F /dt = 100A/μs		4.5		μC	

Notes

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature
- 2. I_{AS} = 9A, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25 $^{\circ}$ C
- 3. Pulse Test: Pulse width ≤ 300µs, Duty Cycle ≤ 1%



Typical Characteristics $T_J = 25^{\circ}\text{C}$, unless otherwise noted

Figure 1. Output Characteristics ($T_J = 25^{\circ}C$)

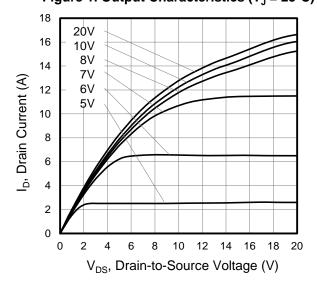


Figure 2. On-Resistance vs. Drain Current

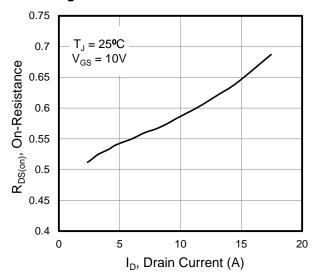


Figure 3. BV_{DSS} vs. Temperature

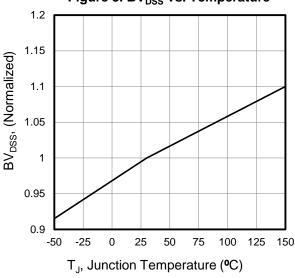


Figure 4. On-Resistance vs. Temperature

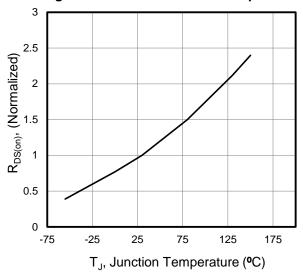


Figure 5. Gate Charge

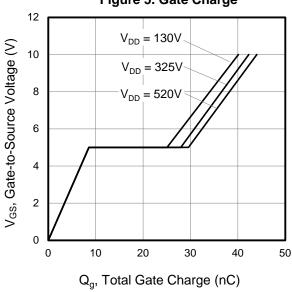
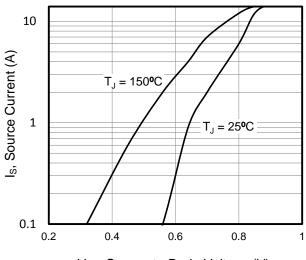


Figure 6. Body Diode Forward Voltage





Typical Characteristics $T_J = 25^{\circ}C$, unless otherwise noted

Figure 7. Transient Thermal Impedance

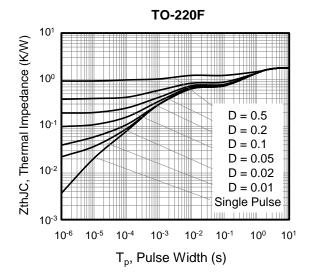


Figure 8. Transient Thermal Impedance

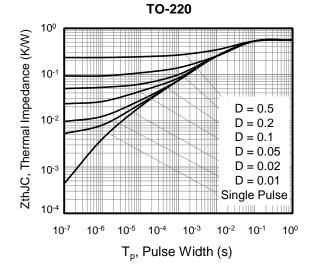




Figure A: Gate Charge Test Circuit and Waveform

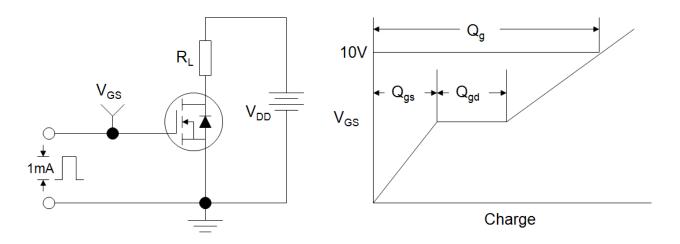


Figure B: Resistive Switching Test Circuit and Waveform

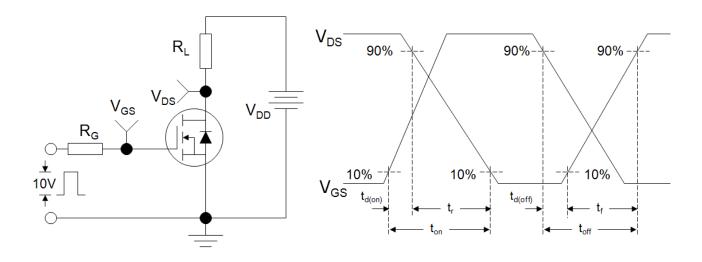
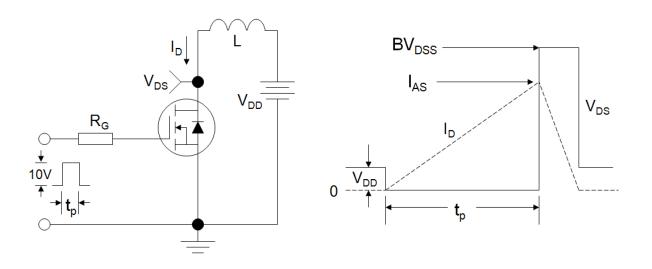


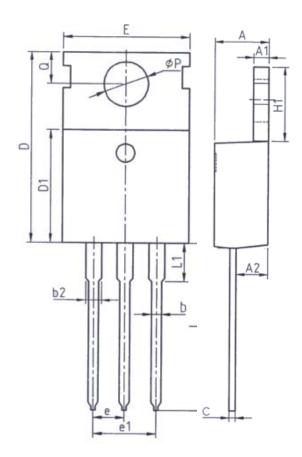
Figure C: Unclamped Inductive Switching Test Circuit and Waveform

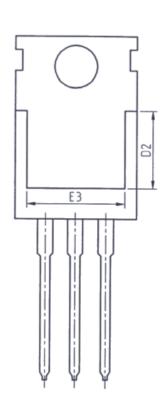


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TO-220



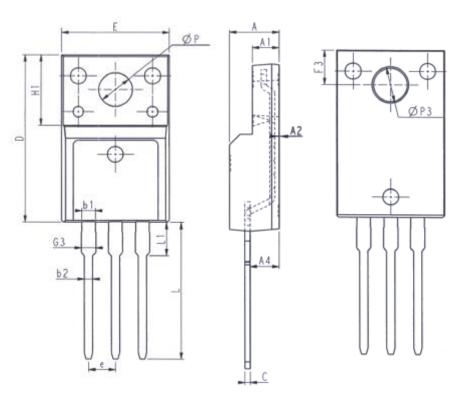


Unit: mm				
Symbol	Min.	Max.		
Α	4. 37	4. 77		
A1	1. 25	1. 45		
A2	2. 20	2. 60		
b	0. 70	0. 95		
b2	1. 17	1. 47		
С	0.40	0. 65		
D	15. 10	16. 10		
D1	8. 80	9. 40		
D2	5. 50	_		

Unit: mm				
Symbol	Min.	Max.		
E	9. 70	10.30		
E3	7. 00 -			
е	2. 54BSC			
e1	5. 08BSC			
H1	6. 25	6. 85		
L	12. 75	13.80		
L1	-	3. 40		
P	3. 40	3. 80		
Q	2.60 3.00			



TO-220F



Unit: mm		Unit: mm			
Symbol	Min.	Max.	Symbol Min. Max		Max.
E	9. 96	10.36	L	12. 68	13. 28
Α	4. 50	4. 90	L1	2. 93	3. 13
A1	2. 34	2. 74	Р	3. 03	3. 38
A2	0. 30	0. 60	Р3	3. 15	3. 65
A4	2. 56	2. 96	F3	3. 15	3. 45
С	0. 40	0. 65	G3	1. 25	1. 55
D	15. 57	16. 17	b1	1. 18	1. 43
H1	6. 70REF		b2	0. 70	0. 95
e	2. 54BSC				



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